

# AP7175

# 3A ULTRA LOW DROPOUT LINEAR REGULATOR WITH ENABLE

### Description

The AP7175 is a 3.0A ultra low-dropout (LDO) linear regulator that features an enable input and a power-good output.

The enable input and power-good output allow users to configure power management solutions that can meet the sequencing requirements of FPGAs, DSPs, and other applications with different start-up and power-down requirements.

The AP7175 features two supply inputs, for power conversion supply and control. With the separation of the control and the power input very low dropout voltages can be reached and power dissipation is reduced.

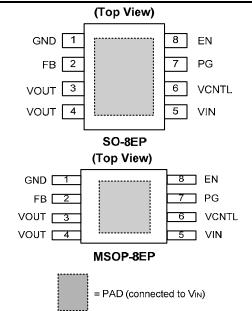
A precision reference and feedback control deliver 1.5% accuracy over load, line, and operating temperature ranges.

The AP7175 is available in SO-8EP and MSOP-8EP package with an exposed PAD to reduce the junction to case resistance and extend the temperature range it can be used in.

### Features

- V<sub>IN</sub> Range: 1.2V to 3.65V V<sub>CNTL</sub> 3.0V to 5.5V
- Adjustable output voltage
- Continuous Output Current I<sub>OUT</sub> = 3A
- Fast transient response
- Power on reset monitoring on V<sub>CNTL</sub> and V<sub>IN</sub>
- Internal Softstart
- Stable with Low ESR MLCC capacitors
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### Pin Assignments



# Applications

- Notebook
- PC
- Netbook
- Wireless Communication
- Server
- Motherboard
- Dongle
- Front Side Bus VTT (1.2V/3.3A)

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</li>

# **Typical Applications Circuit**

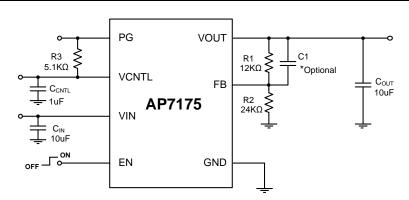


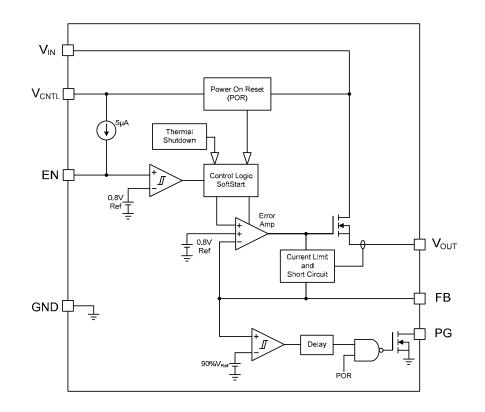
Figure 1. Typical Application Circuit



# **Pin Descriptions**

Pin	Pin Number		Function	
Name	SO-8EP	MSOP-8EP	Function	
GND	1	1	Ground	
FB	2	2	Feedback to set the output voltage via an external resistor divider between VOUT and GND.	
V <sub>OUT</sub>	3/4	3/4	Power Output Pin. Connect at least $10\mu$ F capacitor to this pin to improve transient response and required for stability. When the part is disabled the output is discharged via an internal pull-low MOSFET.	
V <sub>IN</sub>	5	5	Power Input Pin for current supply. Connect a decoupling capacitor ( $\geq 10\mu F$ ) as close as possible to the pin for noise filtering.	
V <sub>CNTL</sub>	6	6	BIAS supply for the controller, recommended 5V. Connect a decoupling capacitor ( $\geq 1\mu$ F) as close as possible to the pin for noise filtering.	
PG	7	7	Power Good output open drain to indicate the status of $V_{OUT}$ via monitoring the FB pin. This pin is pulled low when the voltage is outside the limits, during thermal shutdown and if either $V_{CNTL}$ or $V_{IN}$ go below their thresholds.	
EN	8	8	Enable pin. Driving this pin low will disable the part. When left floating an internal current source will pull this pin high and enable it.	
PAD	EP	EP	Exposed pad connect this to V <sub>IN</sub> for good thermal conductivity.	

# Functional Block Diagram





# Absolute Maximum Ratings (Note 4) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameter	Rating	Unit	
VIN	V <sub>IN</sub> Supply Voltage (V <sub>IN</sub> to GND)	-0.3 to +4.0	V	
V <sub>CNTL</sub>	V <sub>CNTL</sub> Supply Voltage (V <sub>CNTL</sub> to GND)	-0.3 to +7.0	V	
Vout	V <sub>OUT</sub> to GND Voltage	-0.3 to V <sub>IN</sub> +0.3	V	
	PG to GND Voltage	-0.3 to +7.0	V	
	EN, FB to GND Voltage	-0.3 to V <sub>CNTL</sub> +0.3	V	
D	Power Dissipation (SO-8EP)	1.7	W	
PD	Power Dissipation (MSOP-8EP)	1.5		
TJ	Maximum Junction Temperature	150	°C	
T <sub>STG</sub>	Storage Temperature	-65 to +150	°C	
T <sub>SDR</sub>	Maximum Lead Soldering Temperature, 10 Seconds	260	°C	

Note: 4. Stresses greater than the 'Absolute Maximum Ratings' specified above, may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.

## Recommended Operating Conditions (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Pa	Min	Max	Unit	
V <sub>CNTL</sub>	V <sub>CNTL</sub> Supply Voltage		3.0	5.5	V
V <sub>IN</sub>	V <sub>IN</sub> Supply Voltage		1.2	3.65	V
V <sub>OUT</sub>	V <sub>OUT</sub> Output Voltage (when V <sub>CI</sub>	V <sub>OUT</sub> Output Voltage (when V <sub>CNTL</sub> -V <sub>OUT</sub> >1.9V)			V
		Continuous Current	0	3	A
IOUT	V <sub>OUT</sub> Output Current	Peak Current	0	4	
	V <sub>OUT</sub> Output Capacitance	$I_{OUT} = 3A$ at 25% nominal V <sub>OUT</sub>	8	1100	
COUT		$I_{OUT}$ = 2A at 25% nominal V <sub>OUT</sub>	8	1700	μF
	$I_{OUT}$ = 1A at 25% nominal $V_{OL}$		8	2400	
E <sub>SRCOUT</sub>	ESR of VOUT Output Capacitor	0	200	mΩ	
T <sub>A</sub>	Ambient Temperature	-40	+85	°C	
TJ	Junction Temperature	-40	+125	°C	



# **Electrical Characteristics**

(V<sub>CNTL</sub> = 5V, V<sub>IN</sub> = 1.8V, V<sub>OUT</sub> = 1.2V and T<sub>A</sub> = -40 to +85°C, @T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Paramotor	Parameter Test Conditions		AP7175			Unit	
Symbol	Parameter		Test Condi	ions	Min	Тур	Max	Unit
SUPPLY	CURRENT				1	r	1	
IV <sub>CNTL</sub>	V <sub>CNTL</sub> Supply Current	EN = V <sub>CNTL</sub> , I <sub>OUT</sub> =0A			—	1.0	1.5	mA
I <sub>SD</sub>	V <sub>CNTL</sub> Supply Current at Shutdown	EN = GND		—	15	30	μA	
	V <sub>IN</sub> Supply Current at Shutdown	EN = GND, VI	<sub>N</sub> =3.65V		_	—	1	μA
POWER-0	ON-RESET (POR)							
	Rising V <sub>CNTL</sub> POR Threshold				2.5	2.7	2.95	V
	V <sub>CNTL</sub> POR Hysteresis				_	0.4	—	V
	Rising VIN POR Threshold				0.8	0.9	1.0	V
	V <sub>IN</sub> POR Hysteresis				_	0.5	_	V
OUTPUT	VOLTAGE					l		
	Reference Voltage	FB = V <sub>OUT</sub>			_	0.8	_	V
	Output Voltage Accuracy	$V_{CNTL} = 3.0 \sim 3$ T <sub>J</sub> = -40 to +12	5.5V, I <sub>OUT</sub> = 0 to 25°C	ЗА,	-1.5	_	+1.5	%
VREF	Load Regulation	IOUT =0A to 3A			_	0.06	0.25	%
VREF	Line Regulation	$I_{OUT} = 10$ mA, $V_{CNTL} = 3.0$ to 5.5V			-0.15	_	+0.15	%/V
	V <sub>OUT</sub> Pull-low Resistance	$V_{CNTL} = 3.3V, V_{EN} = 0V, V_{OUT} < 0.8V$			_	10	_	Ω
	FB Input Current	$V_{\text{FB}} = 0.8V$				_	100	nA
DROPOU	T VOLTAGE							
	V <sub>IN</sub> -to-V <sub>OUT</sub> Dropout Voltage (Note 5)	$V_{\text{CNTL}} = 5.0V,$ $V_{\text{OUT}} = 3A$ $V_{\text{OUT}} = 1.8V$	V <sub>OUT</sub> = 2.5V	T <sub>J</sub> = +25°C		0.26	0.31	
				T <sub>J</sub> = -40 to +125°C			0.42	
				T <sub>J</sub> = +25°C		0.24	0.29	
Vdrop			V <sub>OUT</sub> = 1.8V	T <sub>J</sub> = -40 to +125°C			0.40	v
			V 1.0V	T <sub>J</sub> = +25°C		0.23	0.28	
		$V_{OUT} = 1.2V$ $T_{J} = -40 \text{ to } +125^{\circ}\text{C}$				0.38		
l	Current-Limit Level	$T_{J} = +25^{\circ}C, V_{J}$	<sub>OUT</sub> = 80% V <sub>NOM</sub>	ЛiNAL	4.5	5.7	6.7	Α
I <sub>LIM</sub>		T <sub>J</sub> = -40 to +125°C		4.2			Α	
PROTEC	TIONS				•		•	-
I <sub>SHORT</sub>	Short Current-Limit Level	$V_{FB} < 0.2V$			—	1.1	—	A
T <sub>SD</sub>	Thermal Shutdown Temperature	$T_J$ rising				170		°C
	Thermal Shutdown Hysteresis				-	50	—	°C
	AND SOFT-START	-						
	EN Logic High Threshold Voltage	$V_{\text{EN}}$ rising			0.5	0.8	1.1	V
	EN Hysteresis					0.1	—	V
_	EN Pull-High Current	EN = GND			—	5	—	uA
T <sub>SS</sub>	Soft-Start Interval				0.3	0.6	1.2	ms
	Turn On Delay	From being ei	nabled to V <sub>OUT</sub>	rising 10%	200	350	500	us
	GOOD AND DELAY						0.5	
V <sub>THPG</sub>	Rising PG Threshold Voltage PG Threshold Hysteresis		V <sub>FB</sub> risin	g	90	92 8	95	%
	PG Pull-low Voltage	PG sinks 5mA	1	1		0.25	0.4	70 V
	PG Debounce Interval	V <sub>FB</sub> < falling F				10		μs
	PG Delay Time	threshold From V <sub>FB</sub> = V	THPG to rising		1	2	4	ms

Note: 5. Dropout voltage is the voltage difference between the inut and the output at which the output voltage drops 2% below its nominal value.



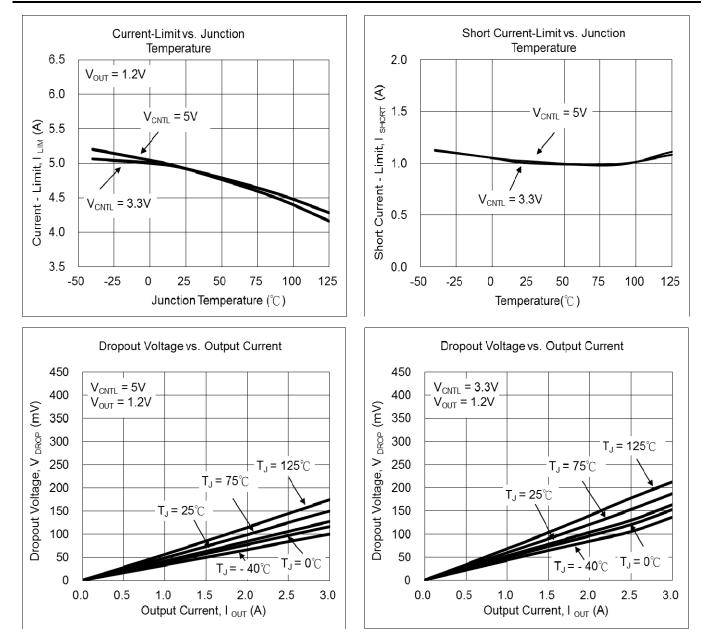
### **Electrical Characteristics** (cont.)

(V<sub>CNTL</sub> = 5V, V<sub>IN</sub> = 1.8V, V<sub>OUT</sub> = 1.2V and T<sub>A</sub> = -40 to +85°C, @T<sub>A</sub> = +25°C, unless otherwise specified.)

Sympol	Deveryorter	Toot Conditions		AP7175			
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit	
THERMAL CHARACTERISTIC							
0	Thermal Resistance Junction-to-Ambient	SO-8EP (Note 6)		70		°C/W	
θ <sub>JA</sub>		MSOP-8EP (Note 7)		80		°C/W	
0	Thermal Resistance Junction-to-Ambient	SO-8EP (Note 6)		30		°C/W	
$\theta_{\rm JC}$		MSOP-8EP (Note 7)		30		°C/W	

6. Device mounted on 2"\*2" FR-4 substrate PC board, 2oz copper, with minimum recommended pad on top layer and thermal vias to bottom layer ground Notes: plane. 7. Device mounted on 2"\*2" FR-4 substrate PC board, 2oz copper,with minimum recommended pad layout.

#### Typical Characteristics

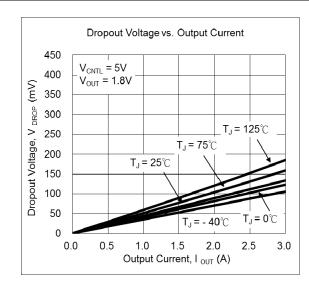


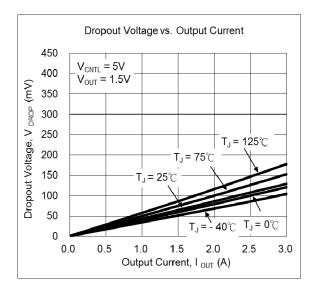
AP7175 Document number: DS35606 Rev. 3 - 2

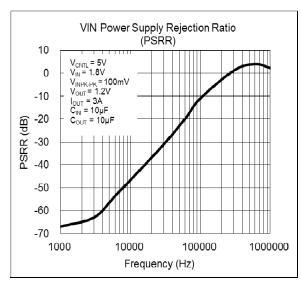


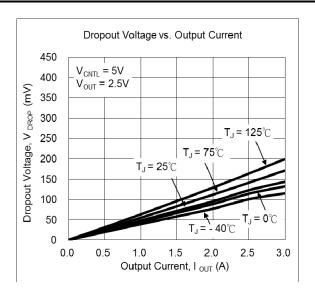
AP7175

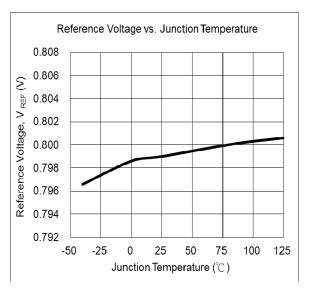
## Typical Characteristics (cont.)

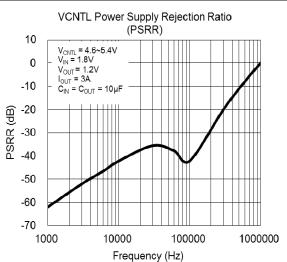






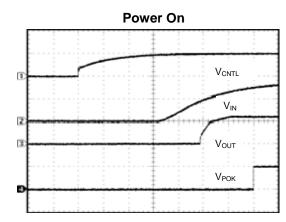




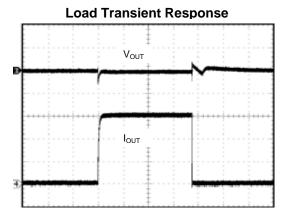




# **Operating Waveforms** (@ $V_{CNTL} = 5V$ , $V_{IN} = 1.8V$ , $V_{OUT} = 1.2V$ , $T_A = +25^{\circ}C$ , unless otherwise specified.)



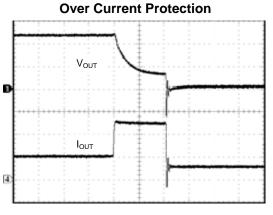
 $\begin{array}{l} C_{OUT}{=}10\mu F, \ C_{IN}{=}10\mu F, \ R_{L}{=}0.4\Omega\\ CH1: \ V_{CNTL}, \ 5V/Div, \ DC\\ CH2: \ V_{IN}, \ 1V/Div, \ DC\\ CH3: \ V_{OUT}, \ 1V/Div, \ DC\\ CH4: \ V_{POK}, \ 5V/Div, \ DC\\ TIME: \ 2ms/Div \end{array}$ 



 $\label{eq:lour_loss} \begin{array}{l} I_{\text{OUT}} = 10\text{mA to 3A to10mA (rise / fall time =1\mus)} \\ C_{\text{OUT}} = 10\mu\text{F}, \ C_{\text{IN}} = 10\mu\text{F} \\ \text{CH1: } V_{\text{OUT}}, \ 50\text{mV/Div}, \ \text{AC} \\ \text{CH2: } I_{\text{OUT}}, \ 1\text{A/Div}, \ \text{DC} \\ \text{TIME: } 50\mu\text{s/Div} \end{array}$ 

Power Off

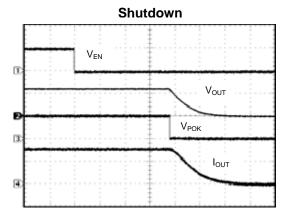
 $\begin{array}{l} C_{OUT}{=}10\mu F,\ C_{IN}{=}10\mu F,\ R_{L}{=}0.4\Omega\\ CH1:\ V_{CNTL},\ 5V/Div,\ DC\\ CH2:\ V_{IN},\ 1V/Div,\ DC\\ CH3:\ V_{OUT},\ 1V/Div,\ DC\\ CH4:\ V_{POK},\ 5V/Div,\ DC\\ TIME:\ 2ms/Div \end{array}$ 



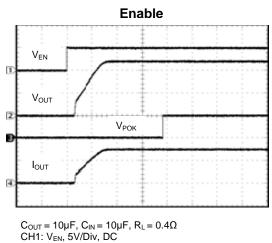
 $\begin{array}{l} C_{OUT}=10\mu F,\,C_{IN}=10\mu F,\,I_{OUT}=2A \text{ to }5.6A\\ CH1:\,V_{OUT},\,0.5V/Div,\,DC\\ CH2:\,I_{OUT},\,2A/Div,\,DC\\ TIME:\,0.2ms/Div \end{array}$ 



# **Operating Waveforms** (cont.) (@ V<sub>CNTL</sub> = 5V, V<sub>IN</sub> = 1.8V, V<sub>OUT</sub> = 1.2V, T<sub>A</sub> = +25°C, unless otherwise specified.)



 $\begin{array}{l} C_{OUT}=10\mu F,\ C_{IN}=10\mu F,\ R_{L}=0.4\Omega\\ CH1:\ V_{EN},\ 5V/Div,\ DC\\ CH2:\ V_{OUT},\ 1V/Div,\ DC\\ CH3:\ V_{POK},\ 5V/Div,\ DC\\ CH4:\ I_{OUT},\ 2A/Div,\ DC\\ TIME:\ 4\mu s/Div \end{array}$ 



$$\label{eq:Course} \begin{split} &C_{OUT}=10\mu F,\ C_{IN}=10\mu F,\ R_L=0.4\Omega\\ &CH1:\ V_{EN},\ 5V/Div,\ DC\\ &CH2:\ V_{OUT},\ 1V/Div,\ DC\\ &CH3:\ V_{POK},\ 5V/Div,\ DC\\ &CH4:\ I_{OUT},\ 2A/Div,\ DC\\ &TIME:\ 1ms/Div \end{split}$$



# **Application Information**

#### Power Good and Delay

AP7175 monitors the feedback voltage  $V_{FB}$  on the FB pin. An internal delay timer is started after the PG voltage threshold ( $V_{THPG}$ ) on the FB pin is reached. At the end of the delay time an internal NMOS of the PG is turned off to indicate that the power at the output is good (PG). This monitoring function is continued during operation and if  $V_{FB}$  falls 8% (typ) below  $V_{THPG}$ , the NMOS of the PG is turned on after a delay time of typical 10µs to avoid oscillating of the PG signal.

#### **Power On Reset**

AP7175 monitors both supply voltages,  $V_{CNTL}$  and  $V_{IN}$  to ensure operation as intended. A Soft-Start process is initiated after both voltages exceed their POR threshold during power on. During operation the POR component continues to monitor the supply voltage and pulls the PG low to indicate an out of regulation supply. This function will engage without regard to the status of the output.

#### Soft-Start

AP7175 incorporates an internal Soft-Start function. The output voltage rise is controlled to limit the current surge during start-up. The typical Soft-Start time is 0.6ms.

#### **Current-Limit Protection**

AP7175 monitors the current flow through the NMOS and limits the maximum current to avoid damage to the load and AP7175 during overload conditions.

#### **Short Circuit Current-Limit Protection**

AP7175 incorporates a current limit function to reduce the maximum current to 1.1A (typ) when the voltage at FB falls below 0.2V (typ) during an overload or short circuit situation.

During start-up period, this function is disabled to ensure successful heavy load start-up.

#### **Enable Control**

If the enable pin (EN) is left open, an internal current source of ~5µA pulls the pin up and enables the AP7175. This will reduce the bill of material saving an external pull up resistor. Driving the enable pin low disables the device. Driving the pin high subsequently initiates a new Soft-Start cycle.

#### **Output Voltage Regulation**

Output Voltage is set by resistor divider from  $V_{OUT}$  via FB pin to GND. Internally  $V_{FB}$  is compared to a 0.8V temperature compensated reference voltage and the NMOS pass element regulates the output voltage while delivering current from  $V_{IN}$  to  $V_{OUT}$ .

#### Setting the Output Voltage

A resistor divider connected to FB pin programs the output voltage.

$$V_{OUT} = V_{REF} * \left( 1 + \frac{R1}{R2} \right) V$$

R1 is connected from V<sub>OUT</sub> to FB with Kelvin sensing connection. R2 is connected from FB to GND. To improve load transient response and stability, a bypass capacitor can be connected in parallel with R1. (optional in typical application circuit)

#### **Power Sequencing**

AP7175 requires no specific sequencing between  $V_{IN}$  and  $V_{CNTL}$ . However, care should be taken to avoid forcing  $V_{OUT}$  for prolonged times without the presence of  $V_{IN}$ . Conduction through internal parasitic diode (from  $V_{OUT}$  to  $V_{IN}$ ) could damage AP7175.

#### Thermal Shutdown

The PCB layout and power requirements for AP7175 under normal operation condition should allow enough cooling to restrict the junction temperature to +125°C. The packages for AP7175 have an exposed PAD to support this. These packages provide better connection to the PCB and thermal performance. Refer to the layout considerations.

If AP7175 junction temperature reaches +170°C a thermal protection block disables the NMOS pass element and lets the part cool down. After its junction temperature drops by 50°C (typ), a new Soft-Start cycle will be initiated. A new thermal protection will start, if the load or ambient conditions continue to raise the junction temperature to +170°C. This cycle will repeat until normal operation temperature is maintained again.



### Application Information (cont.)

#### **Output Capacitor**

An output capacitor (C<sub>OUT</sub>) is needed to improve transient response and maintain stability. The ESR (equivalent series resistance) and capacitance drives the selection. Care needs to be taken to cover the entire operating temperature range.

The output capacitor can be an Ultra-Low-ESR ceramic chip capacitor or a low ESR bulk capacitor like a solid tantalum, POSCap or aluminum electrolytic capacitor.

C<sub>OUT</sub> is used to improve the output stability and reduces the changes of the output voltage during load transitions. The slew rate of the current sensed via the FB pin in AP7175 is reduced. If the application has large load variations, it is recommended to utilize low-ESR bulk capacitors. It is recommended to place ceramic capacitors as close as possible to the load and the ground pin and care should be taken to reduce the impedance in the layout.

#### **Input Capacitor**

To prevent the input voltage from dropping during load steps it is recommended to utilize an input capacitor ( $C_{IN}$ ). As with the output capacitor the following are acceptable, Ultra-Low-ESR ceramic chip capacitor or low ESR bulk capacitor like a solid tantalum, POSCap or aluminum electrolytic capacitor. Typically it is recommended to utilize an capacitance of at least 10µF to avoid output voltage drop due to reduced input voltage. The value can be lower if  $V_{IN}$  changes are not critical for the application.

#### Layout Considerations

For good ground loop and stability, the input and output capacitors should be located close to the input, output, and ground pins of the device. No other application circuit is connected within the loop. Avoid using vias within ground loop. If vias must be used, multiple vias should be used to reduce via inductance.

The regulator ground pin should be connected to the external circuit ground to reduce voltage drop caused by trace impedance. Ground plane is generally used to reduce trace impedance.

Wide trace should be used for large current paths from  $V_{IN}$  to  $V_{OUT}$ , and load circuit.

Place the R1, R2, and C1(optional) near the LDO as close as possible to avoid noise coupling.

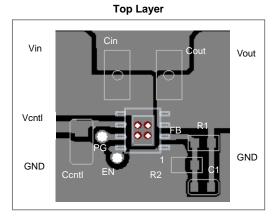
R2 is placed close to device ground. Connect the ground of the R2 to the GND pin by using a dedicated trace.

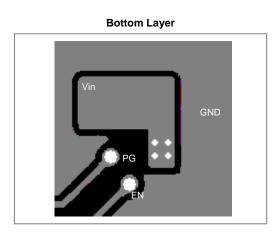
Connect the pin of the R1 directly to the load for Kelvin sensing.

No high current should flow through the ground trace of feedback loop and affect reference voltage stability.

For the packages with exposed pads, heat sinking is accomplished using the heat spreading capability of the PCB and its copper traces. Suitable PCB area on the top layer and thermal vias(0.3mm drill size with 1mm spacing, 4~8 vias at least) to the Vin power plane can help to reduce device temperature greatly.

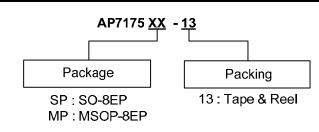
#### **Reference Layout Plots**





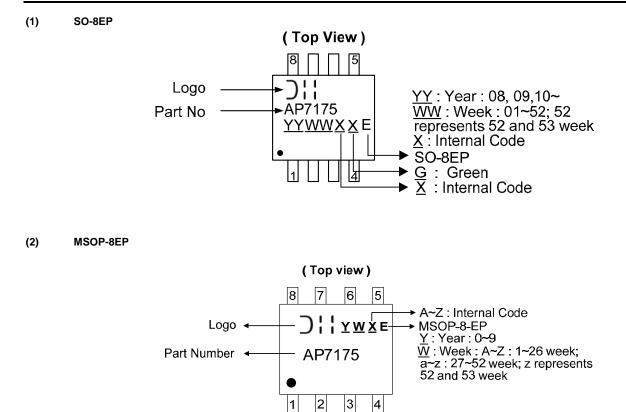


# **Ordering Information**



	Part Number	Baakaga Cada	Pookoging	13" Tape and Reel	
	Fall Nulliper	Package Code	Packaging	Quantity	Part Number Suffix
<b>P0,</b>	AP7175SP-13	SP	SO-8EP	2500/Tape & Reel	-13
<b>B</b>	AP7175MP-13	MP	MSOP-8EP	2500/Tape & Reel	-13

## **Marking Information**

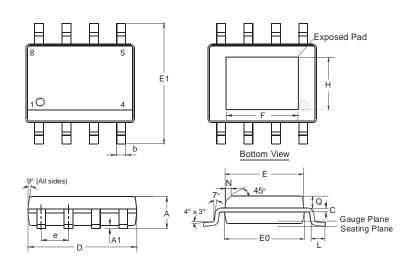




## Package Outline Dimensions (All dimensions in mm.)

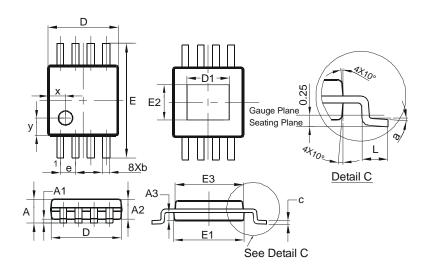
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

(1) SO-8EP



SO-8EP (SOP-8L-EP)					
Dim	Min	Max	Тур		
Α	1.40	1.50	1.45		
A1	0.00	0.13	1		
b	0.30	0.50	0.40		
С	0.15	0.25	0.20		
D	4.85	4.95	4.90		
Е	3.80	3.90	3.85		
E0	3.85	3.95	3.90		
E1	5.90	6.10	6.00		
е	-	-	1.27		
F	2.75	3.35	3.05		
Η	2.11	2.71	2.41		
L	0.62	0.82	0.72		
Ν	-	-	0.35		
Q	0.60	0.70	0.65		
All D	Dimens	sions ir	n mm		

### (2) MSOP-8EP



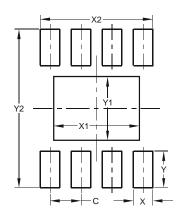
	MSOF	P-8EP	
Dim	Min	Max	Тур
Α	-	1.10	-
A1	0.05	0.15	0.10
A2	0.75	0.95	0.86
A3	0.29	0.49	0.39
b	0.22	0.38	0.30
С	0.08	0.23	0.15
D	2.90	3.10	3.00
D1	1.60	2.00	1.80
Е	4.70	5.10	4.90
E1	2.90	3.10	3.00
E2	1.30	1.70	1.50
E3	2.85	3.05	2.95
е	-	-	0.65
L	0.40	0.80	0.60
а	0°	8°	4°
х	-	-	0.750
У	-	-	0.750
All C	Dimens	ions in	mm



# Suggested Pad Layout

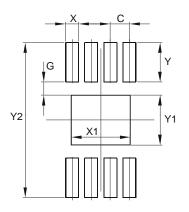
Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

(1) SO-8EP



Dimensions	Value
Dimensions	(in mm)
С	1.270
Х	0.802
X1	3.502
X2	4.612
Y	1.505
Y1	2.613
Y2	6.500

### (2) MSOP-8EP



Dimensions	Value (in mm)
С	0.650
G	0.450
Х	0.450
X1	2.000
Y	1.350
Y1	1.700
Y2	5.300



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- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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